

**FEE TRANSMITTAL**

Electronic Version v08

Stylesheet Version v08.0

**Title of  
Invention**[METHOD OF FORMING CONTACT OPENING AND METHOD OF FORMING  
SEMICONDUCTOR DEVICE]

Application Number :

Date :

First Named Applicant: Mr. Fang-Yu Yeh

Attorney Docket Number: 11209-US-PA

**TOTAL FEE AUTHORIZED \$ 790**

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

**BASIC FILING FEE**

Fee Description	Fee Code	Amount \$	Fee Paid \$
Utility Filing Fee	1001	750	750
Subtotal For Basic Filing Fees: \$ 750			

**EXTRA CLAIM FEES**

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$
Total Claims : 19	0	1202	18	0
Independent Claims : 2	0	1201	84	0
Subtotal For Extra Claims Fees: \$ 0				

**ASSIGNMENT FEES**

Fee Description	Property Number	Quantity	Fee Code	Amount \$	Fee Paid \$
Recording Each Patent Assignment Per Property Fee	00000000	1	8021	40	40
Subtotal For Additional Fees: \$40					

**AUTHORIZED BILLING INFORMATION****The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:**

Credit account number: 1009  
Expiration Date (YYYYMMDD): 2005-12-31  
Authorized name: YEH, WEN-HUNG  
Billing address: 99999